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LED2000

3 A monolithic step-down current source with synchronous rectification

Datasheet - production data

VFQFPN8 4x4   **SO8**

Features

- 3.0 V to 18 V operating input voltage range
- 850 kHz fixed switching frequency
- 100 mV typ. current sense voltage drop
- PWM dimming
- $\pm$ 7% output current accuracy
- Synchronous rectification
- 95 mΩ HS / 69 mΩ LS typical $R_{DS(on)}$
- Peak current mode architecture
- Embedded compensation network
- Internal current limiting
- Ceramic output capacitor compliant
- Thermal shutdown

Applications

- High brightness LED driving
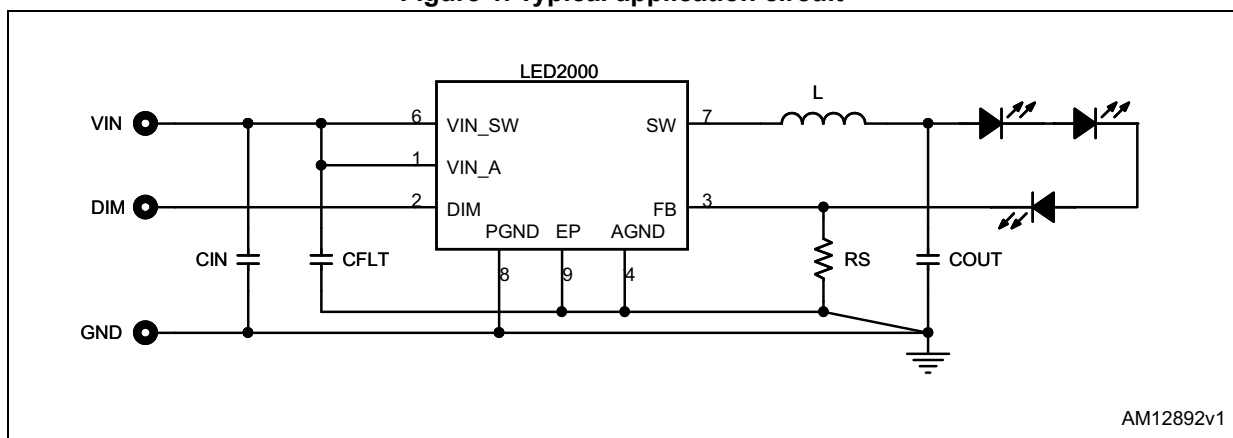- Halogen bulb replacement
- General lighting
- Signage

Description

The LED2000 is an 850 kHz fixed switching frequency monolithic step-down DC-DC converter designed to operate as precise constant current source with an adjustable current capability up to 3 A DC. The embedded PWM dimming circuitry features LED brightness control. The regulated output current is set connecting a sensing resistor to the feedback pin. The embedded synchronous rectification and the 100 mV typical R_{SENSE} voltage drop enhance the efficiency performance. The size of the overall application is minimized thanks to the high switching frequency and ceramic output capacitor compatibility. The device is fully protected against thermal overheating, overcurrent and output short-circuit. The LED2000 is available in VFQFPN 4 mm x 4 mm 8-lead, and standard SO8 package.

Figure 1. Typical application circuit

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1.1 Pin connection

Figure 2. Pin connection (top view)
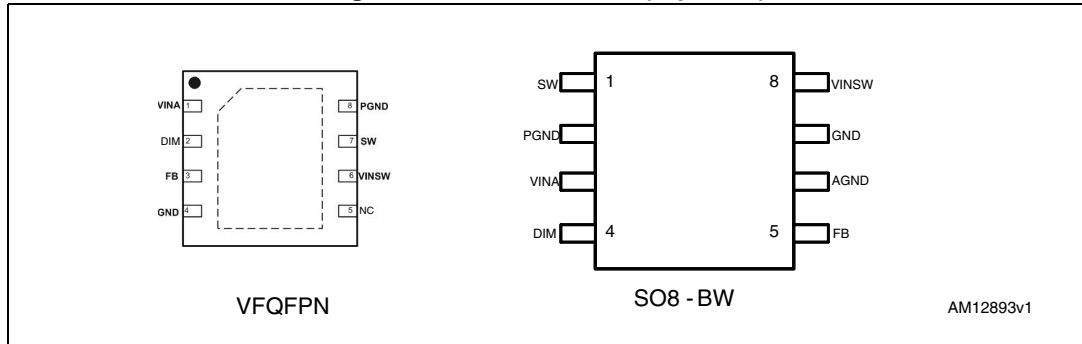
1.2 Pin description

Table 1. Pin description

Package/pin		Type	Description
VFQFPN	S08-BW		
1	3	VIN_A	Analog circuitry power supply connection
2	4	DIM	Dimming control input. Logic low prevents the switching activity, logic high enables it. A square wave on this pin implements LED current PWM dimming. Connect to VIN_A if not used (see *Section 6.6*)
3	5	FB	Feedback input. Connect a proper sensing resistor to set the LED current
4	6	AGND	Analog circuitry ground connection
5	-	NC	Not connected
6	8	V_{INSW}	Power input voltage
7	1	SW	Regulator switching pin
8	2	PGND	Power ground
-	7	GND	Connect to AGND

2 Maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{INSW}	Power input voltage	-0.3 to 20	V
V_{INA}	Input voltage	-0.3 to 20	
V_{DIM}	Dimming voltage	-0.3 to V_{INA}	
V_{SW}	Output switching voltage	-1 to V_{IN}	
V_{PG}	Power Good	-0.3 to V_{IN}	
V_{FB}	Feedback voltage	-0.3 to 2.5	
I_{FB}	FB current	-1 to +1	mA
P_{TOT}	Power dissipation at $T_A < 60$ °C	2	W
T_{OP}	Operating junction temperature range	-40 to 150	°C
T_{stg}	Storage temperature range	-55 to 150	°C

3 Thermal data

Table 3. Thermal data

Symbol	Parameter		Value	Unit
R_{thJA}	Maximum thermal resistance junction-ambient[1]	VFQFPN	40	°C/W
		SO8-BW	65	

1. Package mounted on demonstration board.

4 Electrical characteristics

T_J = 25 °C, V_{CC} = 12 V, unless otherwise specified.

Table 4. Electrical characteristics

Symbol	Parameter	Test conditions	Value			Unit
			Min.	Typ.	Max.	
V_{IN}	Operating input voltage range	See[1]	3		18	V
	Device ON level		2.6	2.75	2.9	
	Device OFF level		2.4	2.55	2.7	
V_{FB}	Feedback voltage	T_J = 25 °C	90	97	104	mV
		T_J = 125 °C	90	100	110	
I_{FB}	V_{FB} pin bias current	See[1]			600	nA
R_{DSON}-P	High-side switch on-resistance	I_{SW} = 750 mA		95		mΩ
R_{DSON}-N	Low-side switch on-resistance	I_{SW} = 750 mA		69		mΩ
I_{LIM}	Maximum limiting current	See[2]		5		A
Oscillator						
F_{SW}	Switching frequency		0.7	0.85	1	MHz
D	Duty cycle	See[2]	0		100	%
DC characteristics						
I_Q	Quiescent current			1.5	2.5	mA
Dimming						
V_{DIM}	DIM threshold voltage	Switching activity	1.2			V
		Switching activity prevented			0.4	
I_{DIM}	DIM current			2		µA
Soft-start						
T_{SS}	Soft-start duration			1		ms
Protection						
T_{SHDN}	Thermal shutdown			150		°C
	Hystereris			15		

1. Specifications referred to T_J from -40 to +125 °C. Specifications in the -40 to +125 °C temperature range are assured by design, characterization and statistical correlation.

2. Guaranteed by design.

5 Functional description

The LED2000 device is based on a "peak current mode" architecture with fixed frequency control. As a consequence, the intersection between the error amplifier output and the sensed inductor current generates the control signal to drive the power switch.

The main internal blocks shown in the block diagram in *Figure 3* are:

- High-side and low-side embedded power element for synchronous rectification
- A fully integrated sawtooth oscillator with a typical frequency of 850 kHz
- A transconductance error amplifier
- A high-side current sense amplifier to track the inductor current
- A pulse width modulator (PWM) comparator and the circuitry necessary to drive the internal power element
- The soft-start circuitry to decrease the inrush current at power-up
- The current limitation circuit based on the pulse-by-pulse current protection with frequency divider
- The dimming circuitry for output current PWM
- The thermal protection function circuitry.

Figure 3. LED2000 block diagram
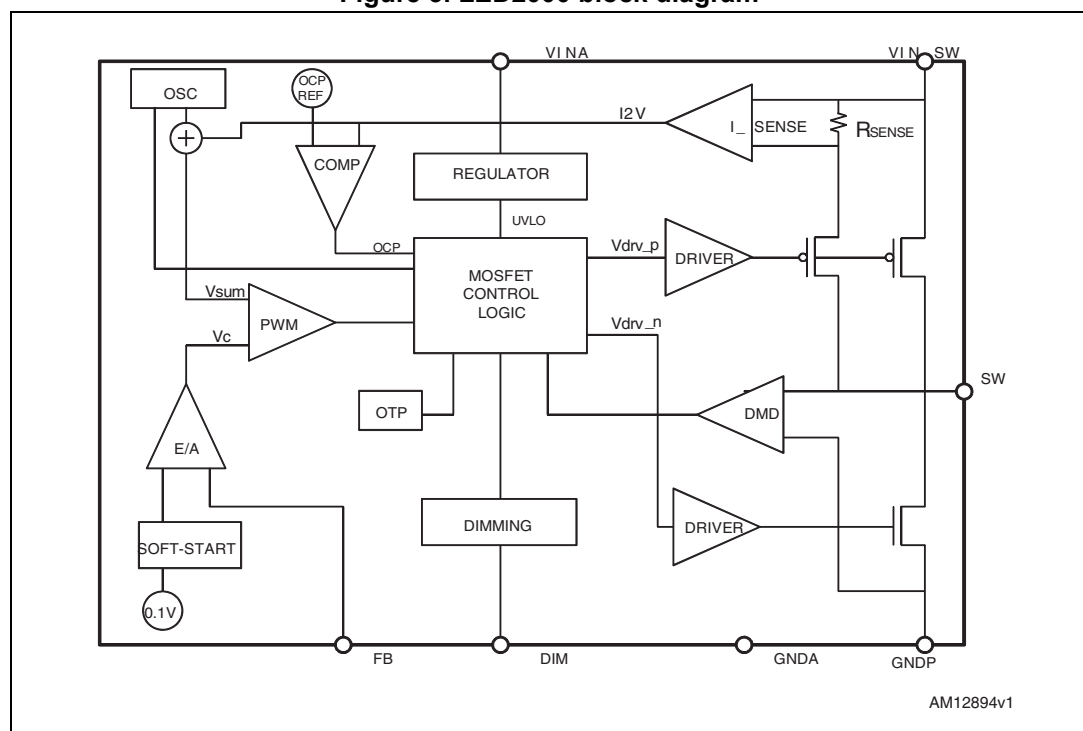
5.1 Power supply and voltage reference

The internal regulator circuit consists of a startup circuit, an internal voltage pre-regulator, the BandGap voltage reference and the bias block that provides current to all the blocks. The starter supplies the startup current to the entire device when the input voltage goes high and the device is enabled. The pre-regulator block supplies the BandGap cell with a pre-regulated voltage that has a very low supply voltage noise sensitivity.

5.2 Voltage monitor

An internal block continuously senses the V_{CC}, V_{ref} and V_{bg}. If the monitored voltages are good, the regulator begins operating. There is also a hysteresis on the V_{CC} (UVLO).

Figure 4. Internal circuit
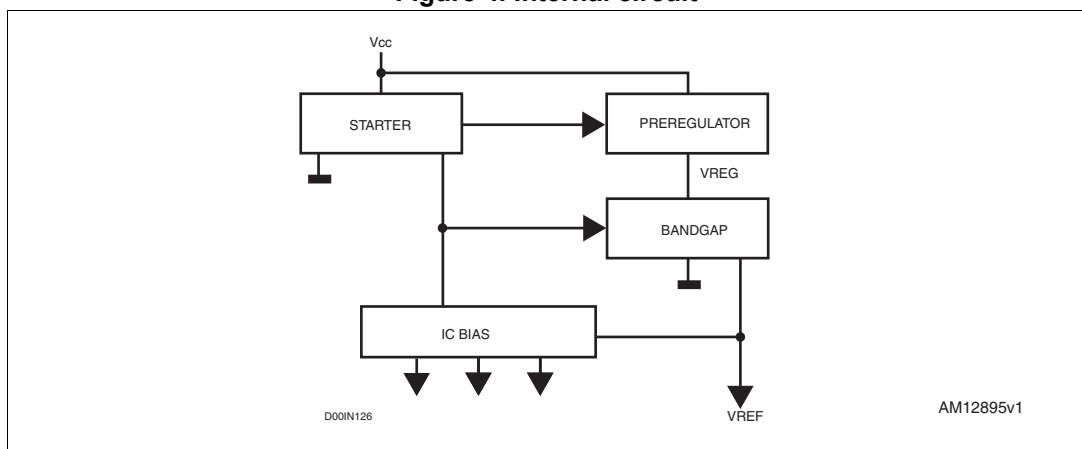
5.3 Soft-start

The startup phase is implemented ramping the reference of the embedded error amplifier in 1 ms typ. time. It minimizes the inrush current and decreases the stress of the power components at power-up.

During normal operation a new soft-start cycle takes place in case of:

- Thermal shutdown event
- UVLO event.

The soft-start is disabled when DIM input goes high in order to maximize the dimming performance.

5.4 Error amplifier

The voltage error amplifier is the core of the loop regulation. It is a transconductance operational amplifier whose non-inverting input is connected to the internal voltage reference (100 mV), while the inverting input (FB) is connected to the output current sensing resistor.

The error amplifier is internally compensated to minimize the size of the final application.

Table 5. Uncompensated error amplifier characteristics

Description	Value
Transconductance	250 µS
Low frequency gain	96 dB
C_C	195 pF
R_C	70 KΩ

The error amplifier output is compared with the inductor current sense information to perform PWM control.

5.5 Thermal shutdown

The shutdown block generates a signal that disables the power stage if the temperature of the chip goes higher than a fixed internal threshold (150 ± 10 °C typical). The sensing element of the chip is close to the PDMOS area, ensuring fast and accurate temperature detection. A 15 °C typical hysteresis prevents the device from turning ON and OFF continuously during the protection operation.

6   Application notes

6.1   Closing the loop

Figure 5. Block diagram of the loop
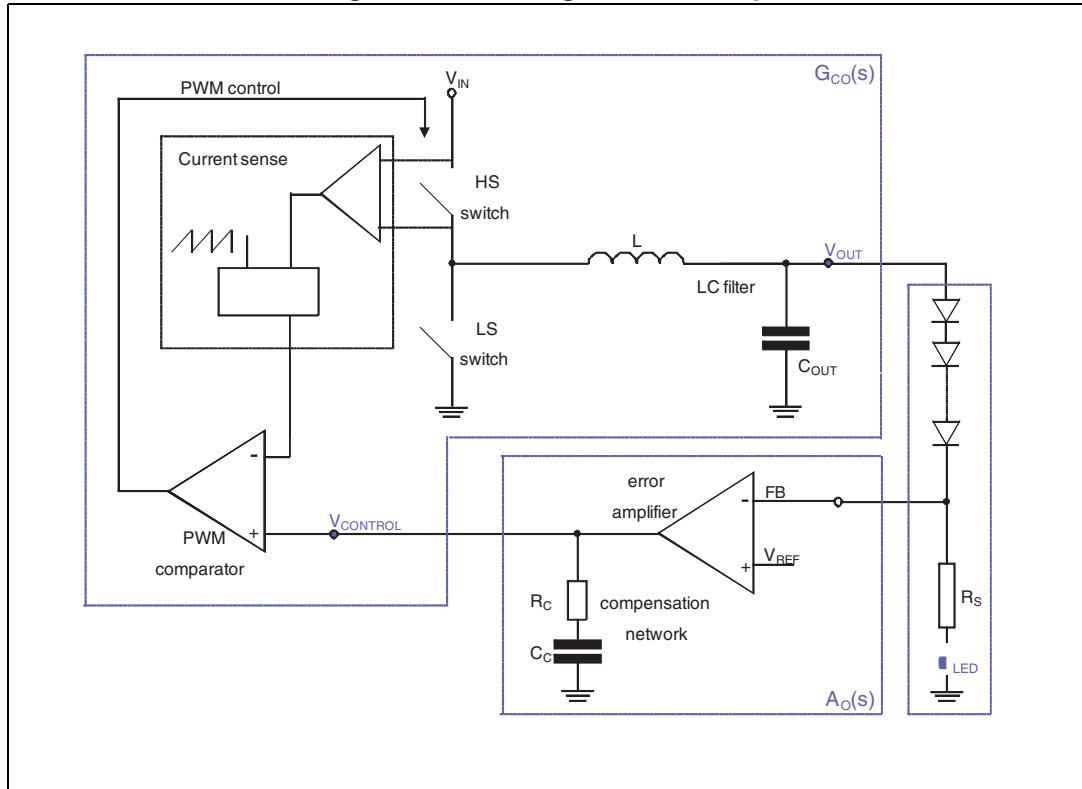
6.2 $G_{CO}(s)$ control to output transfer function

The accurate control to output transfer function for a buck peak current mode converter can be written as:

Equation 1

$$G_{CO}(s) = \frac{R_0}{R_i} \cdot \frac{1}{1 + \dfrac{R_0 \cdot T_{SW}}{L} \cdot [m_C \cdot (1 - D) - 0{,}5]} \cdot \frac{\left(1 + \dfrac{s}{\omega_z}\right)}{\left(1 + \dfrac{s}{\omega_p}\right)} \cdot F_H(s)$$

where R_0 represents the load resistance, R_i the equivalent sensing resistor of the current sense circuitry, ω_p the single pole introduced by the LC filter and ω_z the zero given by the ESR of the output capacitor.

$F_H(s)$ accounts for the sampling effect performed by the PWM comparator on the output of the error amplifier that introduces a double pole at one half of the switching frequency.

Equation 2

$$\omega_Z = \frac{1}{ESR \cdot C_{OUT}}$$

Equation 3

$$\omega_P = \frac{1}{R_{LOAD} \cdot C_{OUT}} + \frac{m_C \cdot (1 - D) - 0,5}{L \cdot C_{OUT} \cdot f_{SW}}$$

where:

Equation 4

$$\begin{cases} m_C = 1 + \dfrac{S_e}{S_n} \\ S_e = V_{pp} \cdot f_{SW} \\ S_n = \dfrac{V_{IN} - V_{OUT}}{L} \cdot R_i \end{cases}$$

S_n represents the slope of the sensed inductor current, S_e the slope of the external ramp (V_{PP} peak-to-peak amplitude) that implements the slope compensation to avoid sub-harmonic oscillations at duty cycle over 50%.

The sampling effect contribution $F_H(s)$ is:

Equation 5

$$F_H(s) = \frac{1}{1 + \dfrac{s}{\omega_n \cdot Q_P} + \dfrac{s^2}{\omega_n^2}}$$

where:

Equation 6
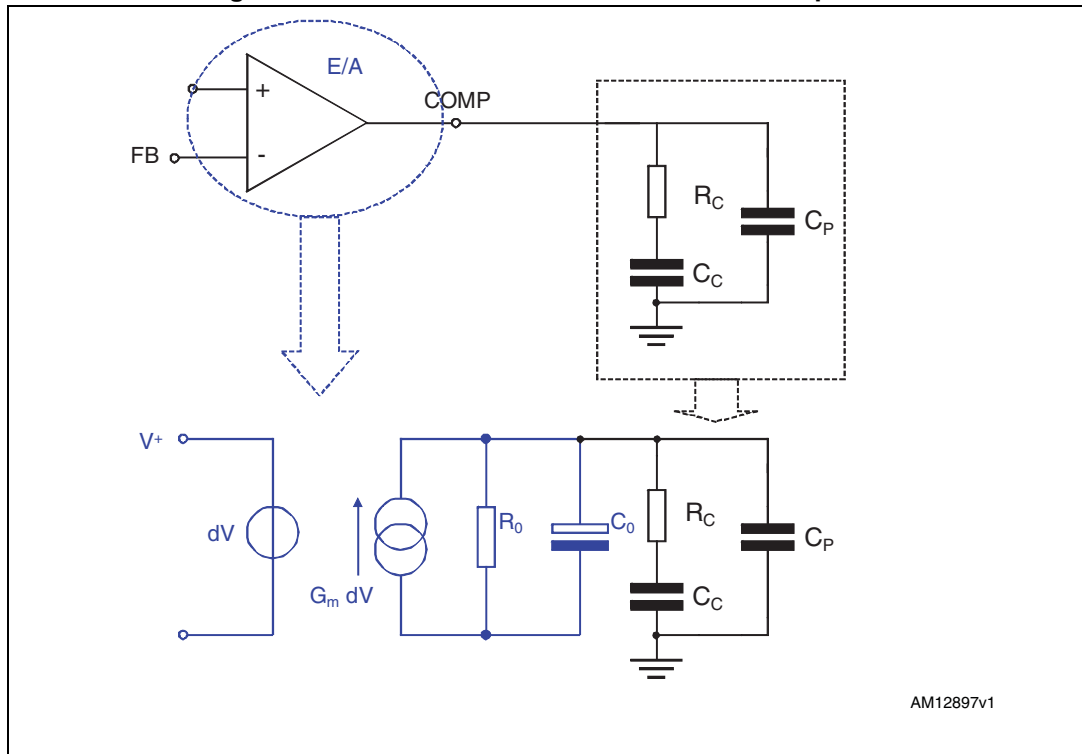
$$\omega_n = \pi \cdot f_{SW}$$

and

Equation 7

$$Q_P = \frac{1}{\pi \cdot [m_C \cdot (1 - D) - 0,5]}$$

6.3 Error amplifier compensation network

The LED2000 device embeds (see *Figure 6*) the error amplifier and a pre-defined compensation network which is effective in stabilizing the system in most application conditions.

Figure 6. Transconductance embedded error amplifier

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R_C and C_C introduce a pole and a zero in the open loop gain. C_P does not significantly affect system stability but it is useful to reduce the noise at the output of the error amplifier.

The transfer function of the error amplifier and its compensation network is:

Equation 8

$$A_0(s) = \frac{A_{V0} \cdot (1 + s \cdot R_c \cdot C_c)}{s^2 \cdot R_0 \cdot (C_0 + C_p) \cdot R_c \cdot C_c + s \cdot (R_0 \cdot C_c + R_0 \cdot (C_0 + C_p) + R_c \cdot C_c) + 1}$$

where $A_{vo} = G_m \cdot R_o$.

The poles of this transfer function are (if $C_C \gg C_0 + C_P$):

Equation 9

$$f_{P\,LF} = \frac{1}{2 \cdot \pi \cdot R_0 \cdot C_c}$$

Equation 10

$$f_{P\,HF} = \frac{1}{2 \cdot \pi \cdot R_c \cdot (C_0 + C_p)}$$

whereas the zero is defined as:

Equation 11

$$F_Z = \frac{1}{2 \cdot \pi \cdot R_c \cdot C_c}$$

The embedded compensation network is R_C = 70 K, C_C = 195 pF while C_P and C_O can be considered as negligible. The error amplifier output resistance is 240 MΩ, so the relevant singularities are:

Equation 12

$$f_Z = 11,6 \text{ kHz} \qquad f_{P\,LF} = 3,4 \text{ Hz}$$

6.4 LED small signal model

Once the system reaches the working condition, the LEDs composing the row are biased and their equivalent circuit can be considered as a resistor for frequencies << 1 MHz.

The LED manufacturer typically provides the equivalent dynamic resistance of the LED biased at different DC currents. This parameter is required to study the behavior of the system in the small signal analysis.

For instance, the equivalent dynamic resistance of the Luxeon III Star from Lumiled measured with different biasing current level is reported below:

Equation 13

$$r_{LED} \begin{cases} 1,3\Omega & I_{LED}= 350\text{mA} \\ 0,9\Omega & I_{LED}= 700\text{mA} \end{cases}$$

If the LED datasheet does not report the equivalent resistor value, it can be simply derived as the tangent to the diode I-V characteristic in the present working point (see *Figure 7*).
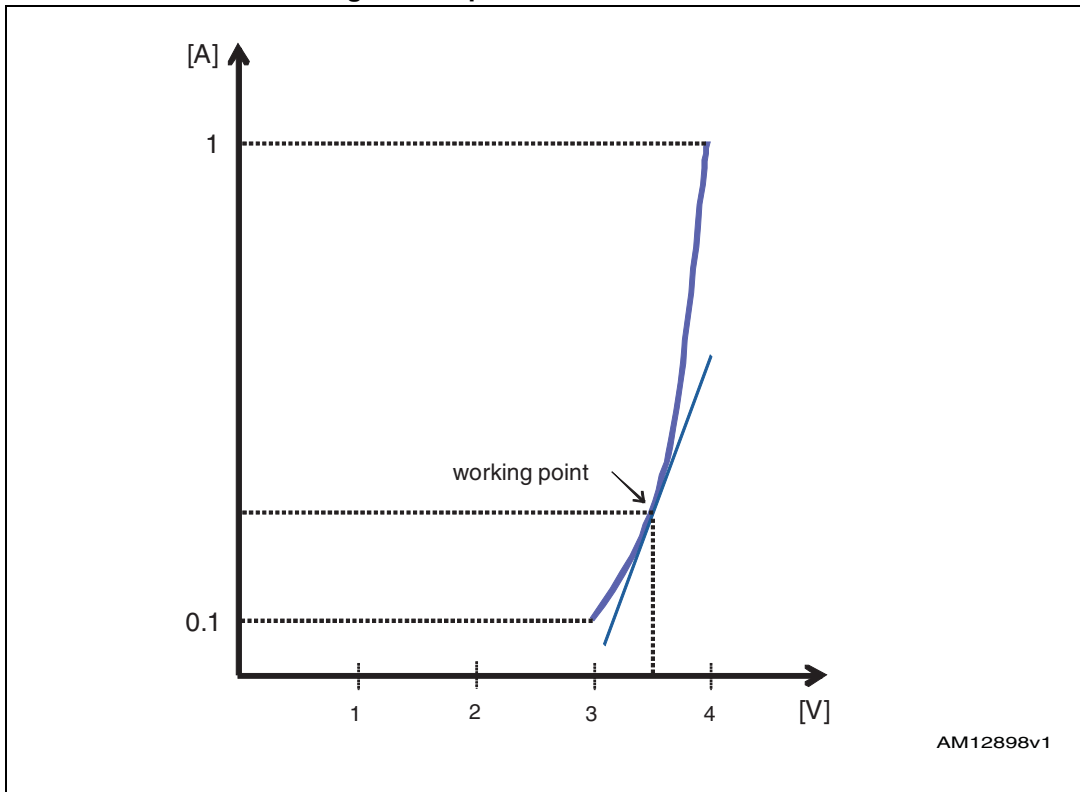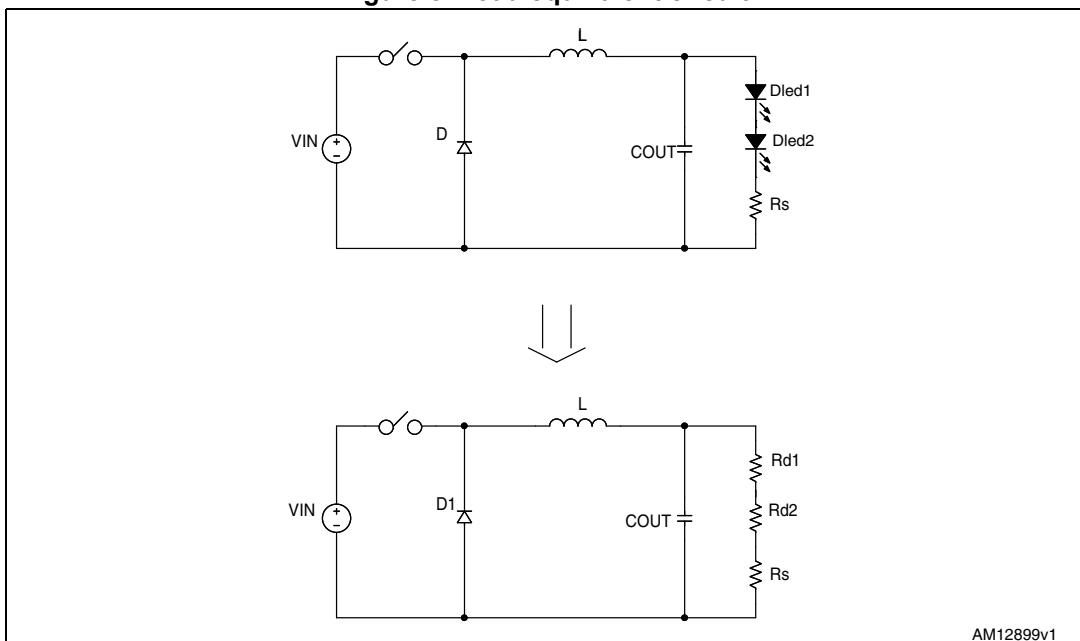
Figure 7. Equivalent series resistor

Figure 8 shows the equivalent circuit of the LED constant current generator.

Figure 8. Load equivalent circuit

As a consequence, the LED equivalent circuit gives the $\alpha_{LED}(s)$ term correlating the output voltage with the high impedance FB input:

Equation 14

$$\alpha_{LED}(n_{LED}) = \frac{R_{SENSE}}{n_{LED} \cdot r_{LED} + R_{SENSE}}$$

6.5 Total loop gain

In summary, the open loop gain can be expressed as:

Equation 15

$$G(s) = G_{CO}(s) \cdot A_0(s) \cdot \alpha_{LED}(n_{LED})$$

Example 1

Design specification:

V_{IN} = 12 V, V_{FW_LED} = 3.5 V, n_{LED} = 2, r_{LED} = 1.1 Ω, I_{LED} = 700 mA, $I_{LED\ RIPPLE}$ = 2%

The inductor and capacitor value are dimensioned in order to meet the $I_{LED\ RIPPLE}$ specification (see *Section 7.1.2* for output capacitor and inductor selection guidelines*):*

L = 10 μH, C_{OUT} = 2.2 μF MLCC (negligible ESR)

Accordingly, with *Section 7.1.1* the sensing resistor value is:

Equation 16

$$R_S = \frac{100\ mV}{700\ mA} \cong 140\ m\Omega$$

Equation 17

$$\alpha_{LED}(n_{LED}) = \frac{R_{SENSE}}{n_{LED} \cdot r_{LED} + R_{SENSE}} = \frac{140\ m\Omega}{2 \cdot 1,1\Omega + 140\ m\Omega} = 0,06$$

The gain and phase margin Bode diagrams are plotted respectively in *Figure 9* and *Figure 10*.

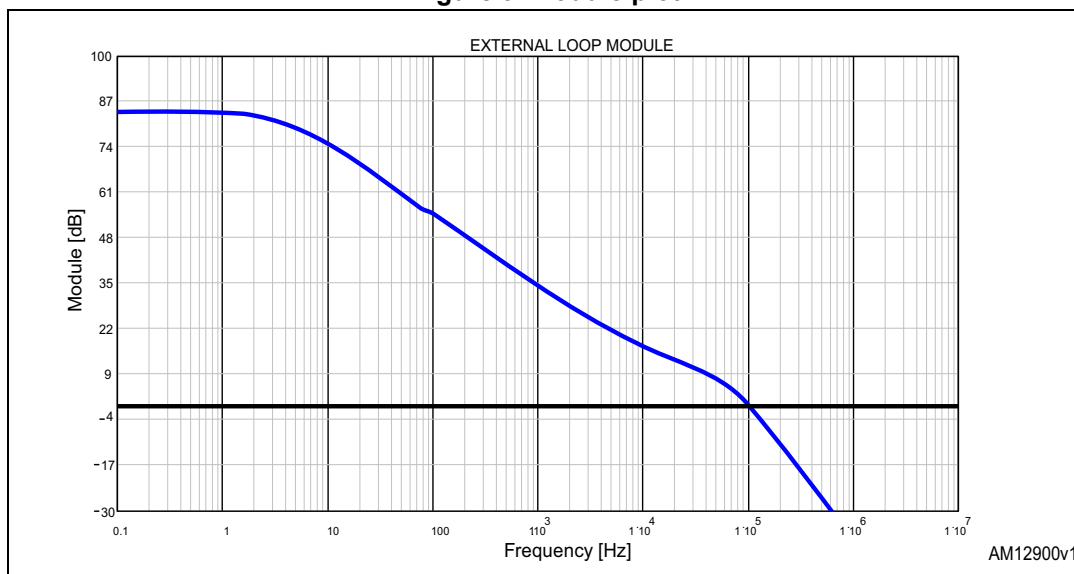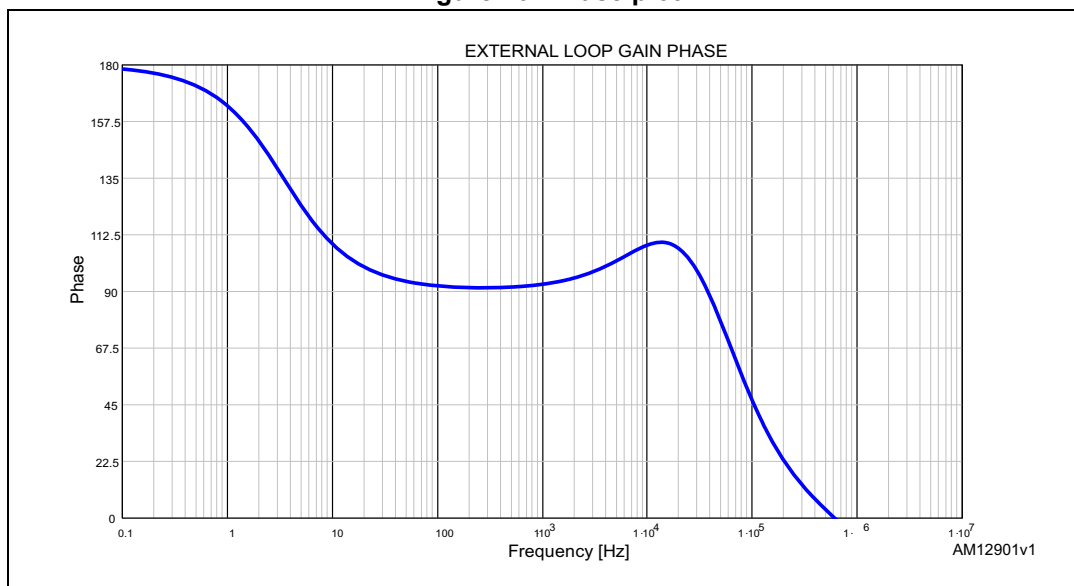**Figure 9. Module plot**

Figure 10. Phase plot

The cut-off frequency and the phase margin are:

Equation 18

$f_C = 100 \text{ kHz} \qquad pm = 47°$

6.6 Dimming operation

The dimming input disables the switching activity, masking the PWM comparator output.

The inductor current dynamic when dimming input goes high depends on the designed system response. The best dimming performance is obtained maximizing the bandwidth and phase margin, when it is possible.

As a general rule, the output capacitor minimization improves the dimming performance.

Figure 11. Dimming operation example
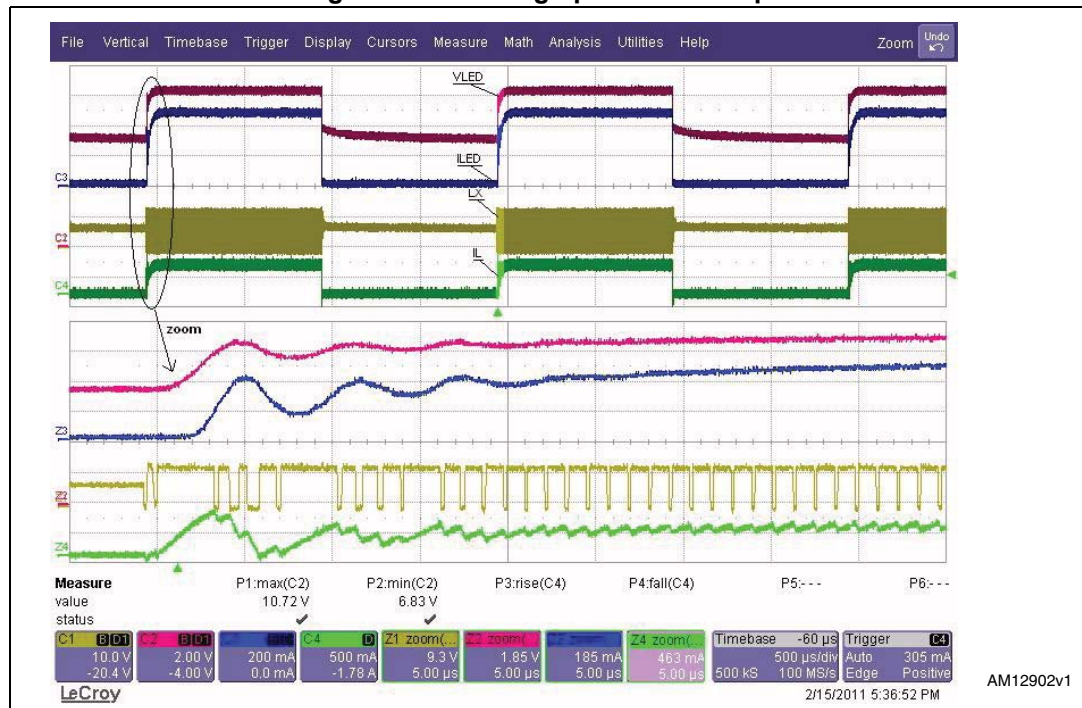
In fact, when dimming enables the switching activity, a small capacitor value is fast charged with low inductor value. As a consequence, the LEDs current rising edge time is improved and the inductor current oscillation reduced. An oversized output capacitor value requires extra current for fast charge so generating certain inductor current oscillations

The switching activity is prevented as soon as the dimming signal goes low. Nevertheless, the LED current drops to zero only when the voltage stored in the output capacitor goes below a minimum voltage determined by the selected LEDs. As a consequence, a big capacitor value makes the LED current falling time worse than a smaller one.

The LED2000 embeds dedicated circuitry to improve LED current falling time.

As soon as the dimming input goes low, the low-side is kept enabled to discharge C_{OUT} until the LED current drops to 60% of the nominal current. A negative current limitation (-1 A typical) protects the device during this operation (see *Figure 12*).

Figure 12. LED current falling edge operation
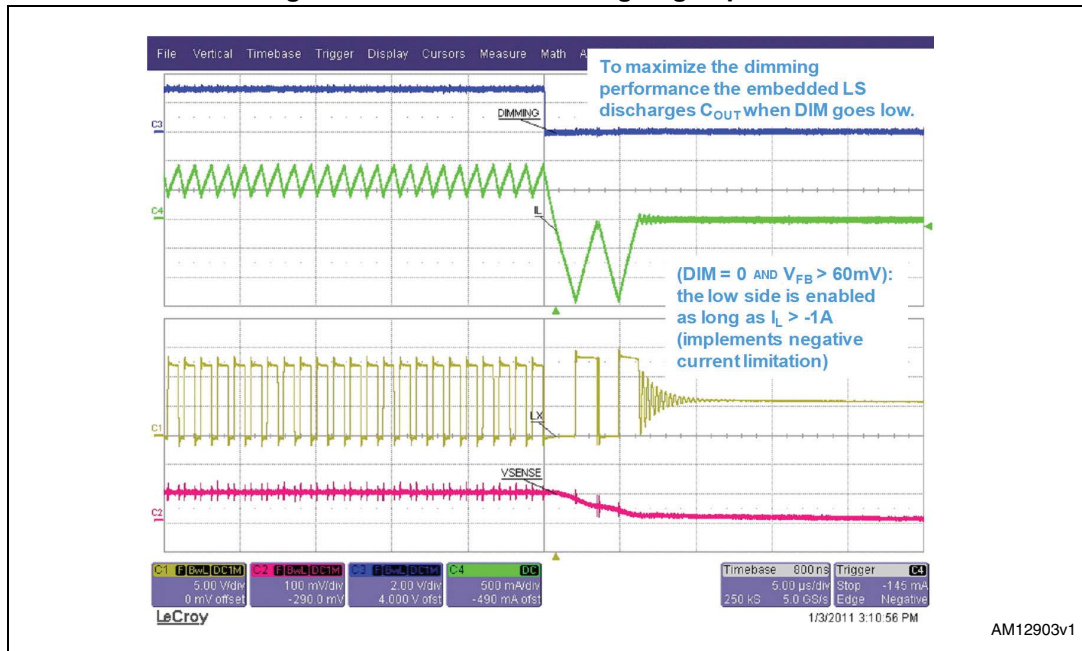
Dimming frequency vs. dimming depth

As seen in *Section 6.6*, the LEDs current rising and falling edge time mainly depends on the system bandwidth (T_{RISE}) and the selected output capacitor value (T_{RISE} and T_{FALL}).

The dimming performance depends on the minimum current pulse shape specification of the final application. The ideal minimum current pulse has rectangular shape, however, it degenerates into a trapezoid or, at worst, into a triangle, depending on the ratio $(T_{RISE} + T_{FALL}) / T_{DIM}$.

Equation 19

$$\textbf{rectangle} \qquad\qquad \textbf{trapezoid} \qquad\qquad \textbf{triangle}$$
$$\frac{T_{RISE} + T_{FALL}}{T_{DIM}} \ll 1 \quad\rightarrow\quad \frac{T_{RISE} + T_{FALL}}{T_{DIM}} < 1 \quad\rightarrow\quad \frac{T_{RISE} + T_{FALL}}{T_{DIM}} = 1$$

The small signal response in *Figure 11* and *Figure 12* is considered as an example.

Equation 20

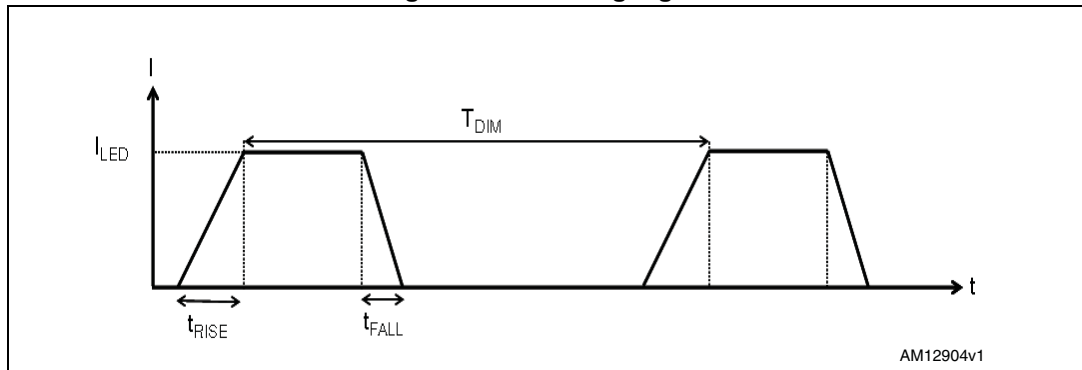$$\begin{cases} T_{RISE} \cong 20\mu s \\ T_{FALL} \cong 5\mu s \end{cases}$$

Assuming the minimum current pulse shape specification as:

Equation 21:

$$T_{RISE} + T_{FALL} = 0,5 \cdot T_{MIN\_PULSE} = 0,5 \cdot D_{MIN} \cdot T_{DIMMING}$$

it is possible to calculate the maximum dimming depth given the dimming frequency or vice versa.

Figure 13. Dimming signal

For example, assuming a 1 kHz dimming frequency the maximum dimming depth is 5% or, given a 2% dimming depth, it follows a 200 Hz maximum f_{DIM}.

The LED2000 dimming performance is strictly dependent on the system small signal response. As a consequence, an optimized compensation (good phase margin and bandwidth maximized) and minimized C_{OUT} value are crucial for the best performance.

6.7 eDesign studio software

The LED2000 device is supported by the eDesign software which can be viewed online at www.st.com.

Figure 14. eDesign studio screenshot
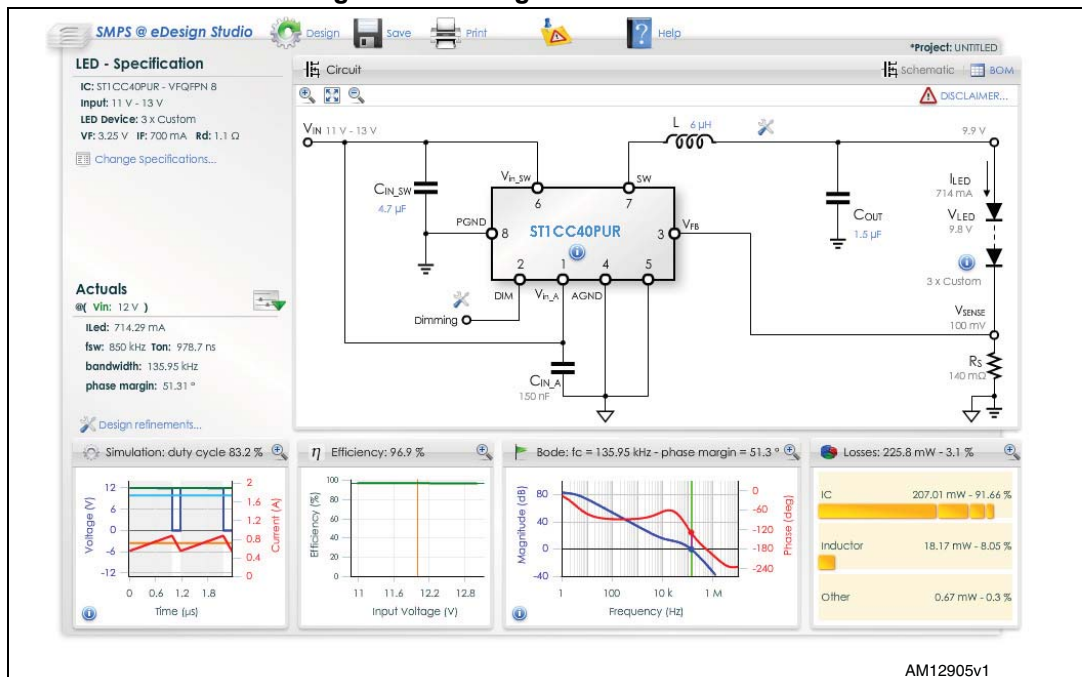
The software easily supports the component sizing according to the technical information given in this datasheet (see *Section 6* and *Section 7*).

The end user is requested to fill in the requested information such as the input voltage range, the selected LED parameters and the number of LEDs composing the row.

The software calculates external components according to the internal database. It is also possible to define new components and ask the software to use them.

Bode plots, estimated efficiency and thermal performance are provided.

Finally, the user can save the design and print all the information including the bill of material of the board.

7 Application information

7.1 Component selection

7.1.1 Sensing resistor

In closed loop operation the LED2000 feedback pin voltage is 100 mV, so the sensing resistor calculation is expressed as:

Equation 22

$$R_S = \frac{100 \text{ mV}}{I_{LED}}$$

Since the main loop (see *Section 6.1*) regulates the sensing resistor voltage drop, the average current is regulated into the LEDs. The integration period is at minimum 5 * T_{SW} since the system bandwidth can be dimensioned up to F_{SW}/5 at maximum.

The system performs the output current regulation over a period which is at least five times longer than the switching frequency. The output current regulation neglects the ripple current contribution and its reliance on external parameters like input voltage and output voltage variations (line transient and LED forward voltage spread). This performance can not be achieved with simpler regulation loops such as a hysteretic control.

For the same reason, the switching frequency is constant over the application conditions, which helps to tune the EMI filtering and to guarantee the maximum LED current ripple specification in the application range. This performance can not be achieved using constant ON/OFF-time architecture.

7.1.2 Inductor and output capacitor selection

The output capacitor filters the inductor current ripple that, given the application condition, depends on the inductor value. As a consequence, the LED current ripple, that is the main specification for a switching current source, depends on the inductor and output capacitor selection.

Figure 15. Equivalent circuit
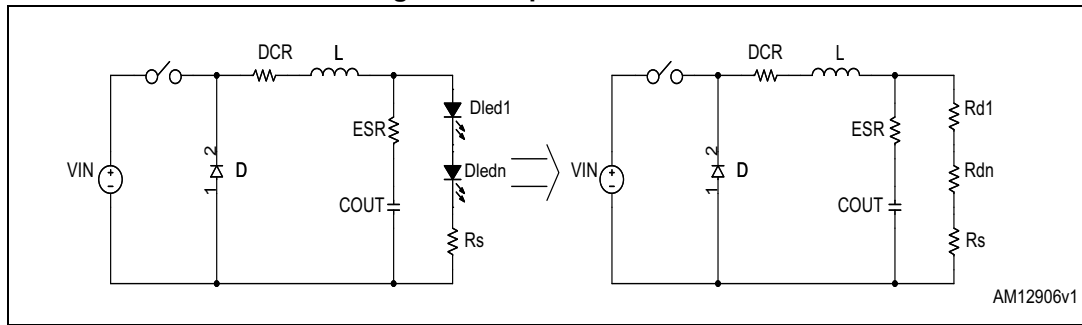
The LED ripple current can be calculated as the inductor ripple current ratio flowing into the output impedance using the Laplace transform (see *Figure 11*):

Equation 23

$$\Delta I_{RIPPLE}(s) = \frac{\frac{8}{\pi^2} \cdot \Delta I_L \cdot (1 + s \cdot ESR \cdot C_{OUT})}{1 + s \cdot (R_S + ESR + n_{LED} \cdot R_{LED}) \cdot C_{OUT}}$$

where the term $8/\pi^2$ represents the main harmonic of the inductor current ripple (which has a triangular shape) and ΔI_L is the inductor current ripple.

Equation 24

$$\Delta I_L = \frac{V_{OUT}}{L} \cdot T_{OFF} = \frac{n_{LED} \cdot V_{FW\_LED} + 100mV}{L} \cdot T_{OFF}$$

so L value can be calculated as:

Equation 25

$$L = \frac{n_{LED} \cdot V_{FW\_LED} + 100mV}{\Delta I_L} \cdot T_{OFF} = \frac{n_{LED} \cdot V_{FW\_LED} + 100mV}{\Delta I_L} \cdot \left(1 - \frac{n_{LED} \cdot V_{FW\_LED} + 100mV}{V_{IN}}\right)$$

where T_{OFF} is the OFF-time of the embedded high switch, given by 1-D.

As a consequence, the lower the inductor value (so the higher the current ripple), the higher the C_{OUT} value would be to meet the specification.

A general rule to dimension L value is:

Equation 26

$$\frac{\Delta I_L}{I_{LED}} \le 0,5$$

Finally, the required output capacitor value can be calculated equalizing the LED current ripple specification with the module of the Fourier transformer (see *Equation 23*) calculated at F_{SW} frequency.

Equation 27

$$\left| \Delta I_{RIPPLE}(s=j \cdot \omega) \right| = \Delta I_{RIPPLE\_SPEC}$$

Example 2(see *Example 1*):

V_{IN} = 12 V, I_{LED} = 700 mA, Δ_{ILED}/I_{LED} = 2%, V_{FW_LED} = 3.5 V, n_{LED} = 2.

A lower inductor value maximizes the inductor current slew rate for better dimming performance. *Equation 26* becomes:

Equation 28

$$\frac{\Delta I_L}{I_{LED}} = 0{,}5$$

which is satisfied selecting a 10 μH inductor value.

The output capacitor value must be dimensioned according to *Equation 27*.

Finally, given the selected inductor value, a 2.2 μF ceramic capacitor value keeps the LED current ripple ratio lower than the 2% of the nominal current. An output ceramic capacitor type (negligible ESR) is suggested to minimize the ripple contribution given a fixed capacitor value.

Table 6. Inductor selection

Manufacturer	Series	Inductor value (μH)	Saturation current (A)
Würth Elektronik	WE-HCI 7040	1 to 4.7	20 to 7
	WE-HCI 7050	4.9 to 10	20 to 4.0
Coilcraft	XPL 7030	2.2 to 10	29 to 7.2

7.1.3 Input capacitor

The input capacitor must be able to support the maximum input operating voltage and the maximum RMS input current.

Since step-down converters draw current from the input in pulses, the input current is squared and the height of each pulse is equal to the output current. The input capacitor must absorb all this switching current, whose RMS value can be up to the load current divided by two (worst case, with duty cycle of 50%). For this reason, the quality of these capacitors must be very high to minimize the power dissipation generated by the internal ESR, thereby improving system reliability and efficiency. The critical parameter is usually the RMS current rating, which must be higher than the RMS current flowing through the capacitor. The maximum RMS input current (flowing through the input capacitor) is:

Equation 29

$$I_{RMS} = I_O \cdot \sqrt{D - \frac{2 \cdot D^2}{\eta} + \frac{D^2}{\eta^2}}$$

where η is the expected system efficiency, D is the duty cycle and I_O is the output DC current. Considering η = 1 this function reaches its maximum value at D = 0.5 and the equivalent RMS current is equal to I_O divided by 2. The maximum and minimum duty cycles are:

Equation 30

$$D_{MAX} = \frac{V_{OUT} + V_F}{V_{INMIN} - V_{SW}}$$

and

Equation 31

$$D_{MIN} = \frac{V_{OUT} + V_F}{V_{INMAX} - V_{SW}}$$

where V_F is the free-wheeling diode forward voltage and V_{SW} the voltage drop across the internal PDMOS. Considering the range D_{MIN} to D_{MAX}, it is possible to determine the max. I_{RMS} going through the input capacitor. Capacitors that can be considered are:

Electrolytic capacitors:

These are widely used due to their low price and their availability in a wide range of RMS current ratings.

The only drawback is that, considering ripple current rating requirements, they are physically larger than other capacitors.

Ceramic capacitors:

If available for the required value and voltage rating, these capacitors usually have a higher RMS current rating for a given physical dimension (due to very low ESR).

The drawback is the considerably high cost.

Tantalum capacitors:

Small tantalum capacitors with very low ESR are becoming more widely available. However, they can occasionally burn if subjected to very high current during charge.

Therefore, it is suggested to avoid this type of capacitor for the input filter of the device as they may be stressed by a high surge current when connected to the power supply.

Table 7. List of ceramic capacitors for the LED2000

Manufacturer	Series	Capacitor value (µC)	Rated voltage (V)
TAIYO YUDEN	UMK325BJ106MM-T	10	50
MURATA	GRM42-2 X7R 475K 50	4.7	50

If the selected capacitor is ceramic (so neglecting the ESR contribution), the input voltage ripple can be calculated as:

Equation 32

$$V_{IN\,PP} = \frac{I_O}{C_{IN} \cdot f_{SW}} \cdot \left[\left(1 - \frac{D}{\eta} \right) \cdot D + \frac{D}{\eta} \cdot (1 - D) \right]$$